



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| BV _{DSS} | RDS(ON) Max | I _D T _A = +25°C | |
|-------------------|--------------------------------|------------------------------------------|--|
| 40\/ | 11mΩ @ V _{GS} = -10V | -11.4A | |
| -40V | 15mΩ @ V _{GS} = -4.5V | -9.8A | |

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature **Environments**
- 100% Unclamped Inductive Switch (UIS) Test in Production Low On-Resistance
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMPH4015SSSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

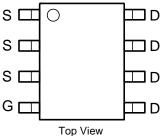
- DC-DC converters
- Power-management functions
- Analog switches

Mechanical Data

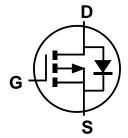
- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)











Equivalent Circuit

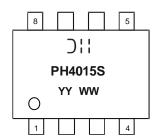
Ordering Information (Note 4)

| Part Number | Package | Packing | | |
|-----------------|---------|---------|-------------|--|
| | Раскауе | Qty. | Carrier | |
| DMPH4015SSSQ-13 | SO-8 | 2,500 | Tape & Reel | |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



⊃!! = Manufacturer's Marking PH4015S = Product Type Marking Code YYWW or YYWW= Date Code Marking YY or \overline{YY} = Year (ex: 24 = 2024) WW = Week (01 to 53)



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|----------------------------------------------------------|-----------------|---------------|------|-----|----|
| Drain-Source Voltage | VDSS | -40 | V | | |
| Gate-Source Voltage | V_{GSS} | ±25 | V | | |
| Continuous Drain Current (Note 6) V _{GS} = -10V | lo | -11.4 -8.1 | А | | |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1% | I _{DM} | -85 | Α | | |
| Maximum Body Diode Continuous Current (Note 6) | | | Is | -3 | Α |
| Avalanche Current, L = 1mH | | | las | -22 | Α |
| Avalanche Energy, L = 1mH | | | Eas | 260 | mJ |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--------------------------------------------------|-------------------|-------------|------|
| Total Power Dissipation (Note 5) | PD | 1.4 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{θJA} | 90 | °C/W |
| Total Power Dissipation (Note 6) | PD | 1.8 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Reja | 70 | °C/W |
| Thermal Resistance, Junction to Case (Note 6) | R _θ JC | 7.0 | °C/W |
| Operating and Storage Temperature Range | TJ, TSTG | -55 to +175 | °C |

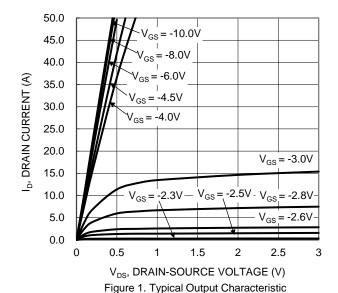
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|---------------------------------------------|-------------------|------|-------|------|-------|----------------------------------------------------------------------------|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -40 | _ | _ | V | $V_{GS} = 0V, I_D = -250\mu A$ | |
| Zero Gate Voltage Drain Current | IDSS | _ | _ | -1 | μA | $V_{DS} = -40V, V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±100 | nA | $V_{GS} = \pm 25V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | Vgs(th) | -1.5 | _ | -2.5 | V | $V_{DS} = V_{GS}$, $I_D = -250\mu A$ | |
| Static Drain-Source On-Resistance | Descour | | 9 | 11 | mΩ | $V_{GS} = -10V, I_D = -9.8A$ | |
| Static Dialii-Source Off-Resistance | RDS(ON) | | 11 | 15 | 11122 | $V_{GS} = -4.5V, I_{D} = -9.8A$ | |
| Forward Transfer Admittance | Y _{fs} | _ | 26 | _ | S | $V_{DS} = -20V$, $I_{D} = -9.8A$ | |
| Diode Forward Voltage | VsD | _ | -0.7 | -1 | V | Vgs = 0V, Is = -1A | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | Ciss | | 4,234 | _ | | V _{DS} = -20V, V _{GS} = 0V f = 1MHz | |
| Output Capacitance | Coss | _ | 1,036 | _ | pF | | |
| Reverse Transfer Capacitance | Crss | _ | 526 | _ | | | |
| Gate Resistance | Rg | _ | 7.8 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ | |
| Total Gate Charge (V _{GS} = -4.5V) | Q_g | _ | 42.7 | _ | | | |
| Total Gate Charge (VGS = -10V) | Qg | _ | 91 | _ | nC | V _{DS} = -20V, I _D = -9.8A | |
| Gate-Source Charge | Qgs | _ | 14.2 | _ | i iiC | | |
| Gate-Drain Charge | Q_{gd} | _ | 13.5 | _ | | | |
| Turn-On Delay Time | tD(ON) | _ | 13.2 | _ | | $V_{GS} = -10V, V_{DD} = -20V, R_G = 6\Omega,$ $I_D = -1A, R_L = 20\Omega$ | |
| Turn-On Rise Time | t _R | _ | 10 | _ | | | |
| Turn-Off Delay Time | tD(OFF) | _ | 303 | _ | ns | | |
| Turn-Off Fall Time | tF | _ | 138 | _ | | | |
| Reverse Recovery Time | t _{RR} | _ | 26 | _ | ns | I _F = -9.8A, di/dt = -100A/µs | |
| Reverse Recovery Charge | Qrr | | 20 | _ | nC | I _F = -9.8A, di/dt = -100A/μs | |

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.





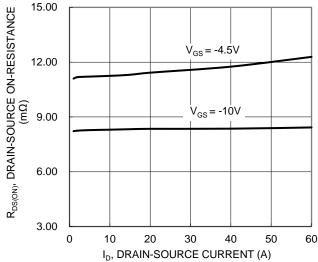


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

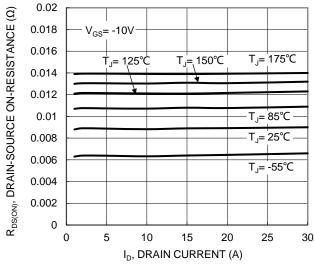
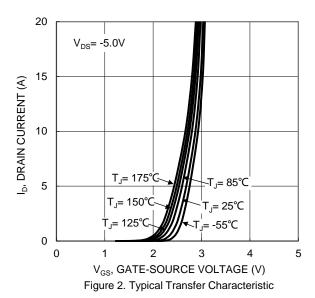
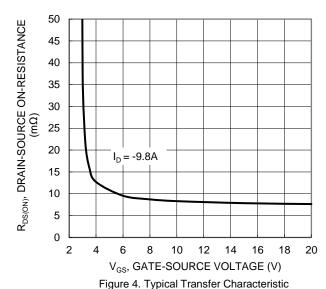


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





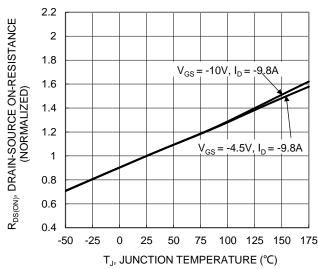


Figure 6. On-Resistance Variation with Temperature





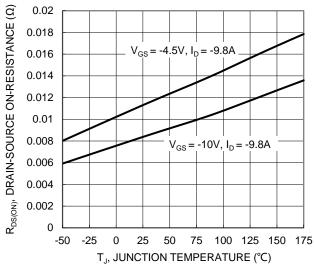
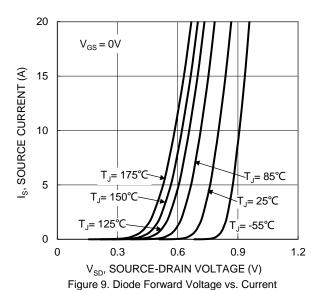


Figure 7. On-Resistance Variation with Temperature



10 8 6 $V_{GS}(V)$ $V_{DS} = -20V, I_{D} = -9.8A$ 4 2 0 0 20 40 60 80 100 120 Qg (nC)

Figure 11. Gate Charge

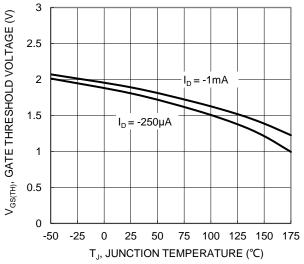
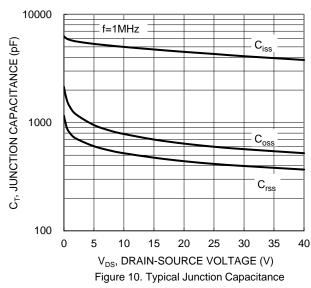
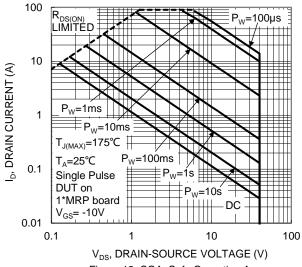


Figure 8. Gate Threshold Variation vs. Junction Temperature







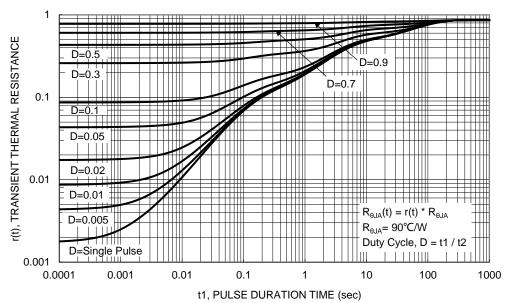
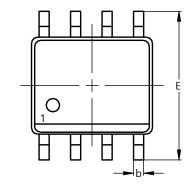


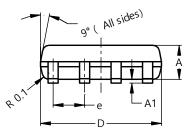
Figure 13. Transient Thermal Resistance

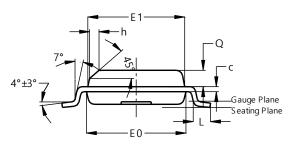


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.







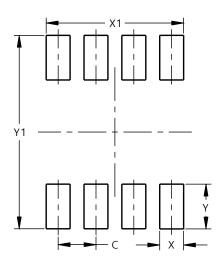
SO-8

| SO-8 | | | | | |
|----------------------|------|------|------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 1.40 | 1.50 | 1.45 | | |
| A1 | 0.10 | 0.20 | 0.15 | | |
| b | 0.30 | 0.50 | 0.40 | | |
| С | 0.15 | 0.25 | 0.20 | | |
| D | 4.85 | 4.95 | 4.90 | | |
| Е | 5.90 | 6.10 | 6.00 | | |
| E1 | 3.80 | 3.90 | 3.85 | | |
| E0 | 3.85 | 3.95 | 3.90 | | |
| е | | | 1.27 | | |
| h | | | 0.35 | | |
| L | 0.62 | 0.82 | 0.72 | | |
| Q | 0.60 | 0.70 | 0.65 | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





| Dimensions | Value (in mm) | | |
|------------|---------------|--|--|
| C | 1.27 | | |
| Х | 0.802 | | |
| X1 | 4.612 | | |
| Υ | 1.505 | | |
| Y1 | 6.50 | | |



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